

# IPS521G

## FULLY PROTECTED HIGH SIDE POWER MOSFET SWITCH

### Features

- Over temperature protection (with auto-restart)
- Short-circuit protection (current limit)
- Active clamp
- E.S.D protection
- Status feedback
- Open load detection
- Logic ground isolated from power ground

### Description

The IPS521G is a fully protected five terminal high side switch with built in short circuit, over-temperature, ESD protection, inductive load capability and diagnostic feedback. The output current is controlled when it reaches  $I_{lim}$  value. The current limitation is activated until the thermal protection acts. The over-temperature protection turns off the high side switch if the junction temperature exceeds  $T_{shutdown}$ . It will automatically restart after the junction has cooled  $7^{\circ}\text{C}$  below  $T_{shutdown}$ . A diagnostic pin is provided for status feedback of short-circuit, over-temperature and open load detection. The double level shifter circuitry allows large offsets between the logic ground and the load ground.

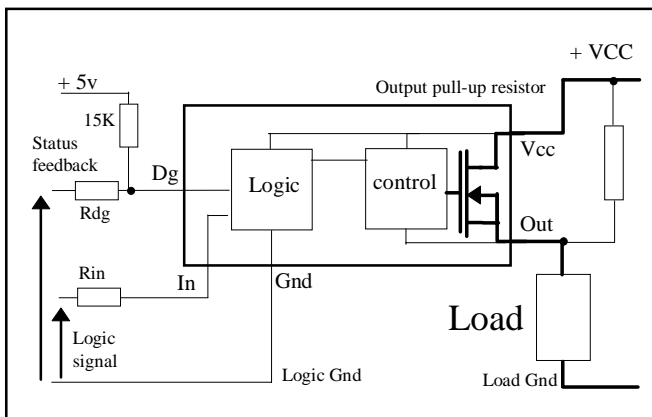
### Product Summary

$R_{ds(on)}$	100mW (max)
$V_{clamp}$	50V
I Limit	10A
$T_{shutdown}$	$165^{\circ}\text{C}$
$V_{open\ load}$	3V

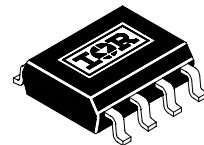
### Truth Table

Op. Conditions	In	Out	Dg
Normal	H	H	H
Normal	L	L	L
Open load	H	H	H
Open load	L	H	H
Over current	H	L (limiting)	L
Over current	L	L	L
Over-temperature	H	L (cycling)	L
Over-temperature	L	L	L

### Typical Connection



### Available Package



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## Absolute Maximum Ratings

Absolute maximum ratings indicates sustained limits beyond which damage to the device may occur. All voltage parameters are referenced to GROUND lead. (T<sub>j</sub> = 25°C unless otherwise specified).

Symbol	Parameter	Min.	Max.	Units	Test Conditions
V <sub>out</sub>	Maximum output voltage	V <sub>CC</sub> -50	V <sub>CC</sub> +0.3	V	
V <sub>offset</sub>	Maximum logic ground to load ground offset	V <sub>CC</sub> -50	V <sub>CC</sub> +0.3		
V <sub>in</sub>	Maximum Input voltage	-0.3	7		
I <sub>in, max</sub>	Maximum positive IN current	-1	10	mA	
V <sub>dg</sub>	Maximum diagnostic output voltage	-0.3	7	V	
I <sub>dg, max</sub>	Maximum diagnostic output current	-1	10	mA	
I <sub>sd cont.</sub>	Diode max. permanent current <sup>(1)</sup> (r <sub>th</sub> = 62°C/W)	—	1.4	A	
I <sub>sd pulsed</sub>	Diode max. pulsed current <sup>(1)</sup>	—	10		
ESD1	Electrostatic discharge voltage (Human Body)	—	4000	V	C=100pF, R=150Ω,
ESD2	Electrostatic discharge voltage (Machine Model)	—	500		C=200pF, R=0Ω,
P <sub>d</sub>	Maximum power dissipation <sup>(1)</sup> (r <sub>th</sub> =125°C/W)	—	1		
T <sub>j max.</sub>	Max. storage & operating junction temp.	-40	+150	°C	

## Thermal Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
R <sub>th1</sub>	Thermal resistance with standard footprint	—	100	125	°C/W	8 Lead SOIC
R <sub>th2</sub>	Thermal resistance with 1" square footprint	—	—	80		

## Recommended Operating Conditions

These values are given for a quick design. For operation outside these conditions, please consult the application notes.

Symbol	Parameter	Min.	Max.	Units
V <sub>CC</sub>	Continuous V <sub>CC</sub> voltage	5.5	35	V
V <sub>IH</sub>	High level input voltage	4	5.5	
V <sub>IL</sub>	Low level input voltage	-0.3	0.9	
I <sub>out</sub>	Continuous output current (T <sub>c</sub> =85°C (T <sub>Ambient</sub> = 85°C, T <sub>j</sub> = 125°C, R <sub>th</sub> = 100°C/W))	—	1.6	A
R <sub>in</sub>	Recommended resistor in series with IN pin	10	20	kΩ
R <sub>dg</sub>	Recommended resistor in series with DG pin	10	20	

(1) Limited by junction temperature (pulsed current limited also by internal wiring)

## Static Electrical Characteristics

( $T_j = 25^\circ\text{C}$ ,  $V_{CC} = 14\text{V}$  unless otherwise specified.)

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$R_{ds(on)}$ @ $T_j=25^\circ\text{C}$	ON state resistance $T_j = 25^\circ\text{C}$	—	80	100	m $\omega$	$V_{in} = 5\text{V}$ , $I_{out} = 5\text{A}$
$R_{ds(on)}$ ( $V_{CC}=6\text{V}$ )	ON state resistance @ $V_{CC} = 6\text{V}$	—	80	—		$V_{in} = 5\text{V}$ , $I_{out} = 2.5\text{A}$
$R_{ds(on)}$ @ $T_j=150^\circ\text{C}$	ON state resistance $T_j = 150^\circ\text{C}$	—	125	—		$V_{in} = 5\text{V}$ , $I_{out} = 5\text{A}$
$V_{CC}$ oper.	Operating voltage range	5.5	—	35	V	
V clamp 1	$V_{CC}$ to OUT clamp voltage 1	50	56	—		$I_d = 10\text{mA}$ (see Fig.1 & 2)
V clamp 2	$V_{CC}$ to OUT clamp voltage 2	—	58	65		$I_d = I_{sd}$ (see Fig.1 & 2)
$V_f$	Body diode forward voltage	—	0.9	1.2		$I_d = 2.5\text{A}$ , $V_{in} = 0\text{V}$
$I_{CC}$ off	Supply current when OFF	—	16	50	mA	$V_{in} = 0\text{V}$ , $V_{out} = 0\text{V}$
$I_{CC}$ on	Supply current when ON	—	0.7	2	mA	$V_{in} = 5\text{V}$
$I_{CC}$ ac	Ripple current when ON (AC RMS)	—	20	—	mA	$V_{in} = 5\text{V}$
$V_{dgl}$	Low level diagnostic output voltage	—	0.15	—	V	$I_{dg} = 1.6\text{mA}$
$I_{ol}$	Output leakage current	—	50	—	mA	$V_{out} = 6\text{V}$
$I_{ol}$	Output leakage current	0	—	25		$V_{out} = 0\text{V}$
$I_{dg}$ leakage	Diagnostic output leakage current	—	—	10		$V_{dg} = 5.5\text{V}$
$V_{ih}$	IN high threshold voltage	—	2.0	2.5	V	
$V_{il}$	IN low threshold voltage	1	1.8	—		
$I_{in, on}$	On state IN positive current	—	70	—	mA	$V_{in} = 5\text{V}$

## Switching Electrical Characteristics

$V_{CC} = 14\text{V}$ , Resistive Load =  $2.8\omega$ ,  $T_j = 25^\circ\text{C}$ , (unless otherwise specified).

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$T_{on}$	Turn-on delay time	—	10	—	ms	See figure 3
$T_{r1}$	Rise time to $V_{out} = V_{CC} - 5\text{V}$	—	25	—		
$T_{r2}$	Rise time to $V_{out} = 90\%$ of $V_{CC}$	—	130	—		
$dV/dt$ (on)	Turn ON $dV/dt$	—	0.7	—	V/ms	
$E_{on}$	Turn ON energy	—	2000	—	mJ	
$T_{off}$	Turn-off delay time	—	35	—	ms	See figure 4
$T_f$	Fall time to $V_{out} = 10\%$ of $V_{CC}$	—	25	—		
$dV/dt$ (off)	Turn OFF $dV/dt$	—	0.9	—		
$E_{off}$	Turn OFF energy	—	600	—	mJ	
$T_{diag}$	$V_{out}$ to $V_{diag}$ propagation delay	—	tbd	—	ms	

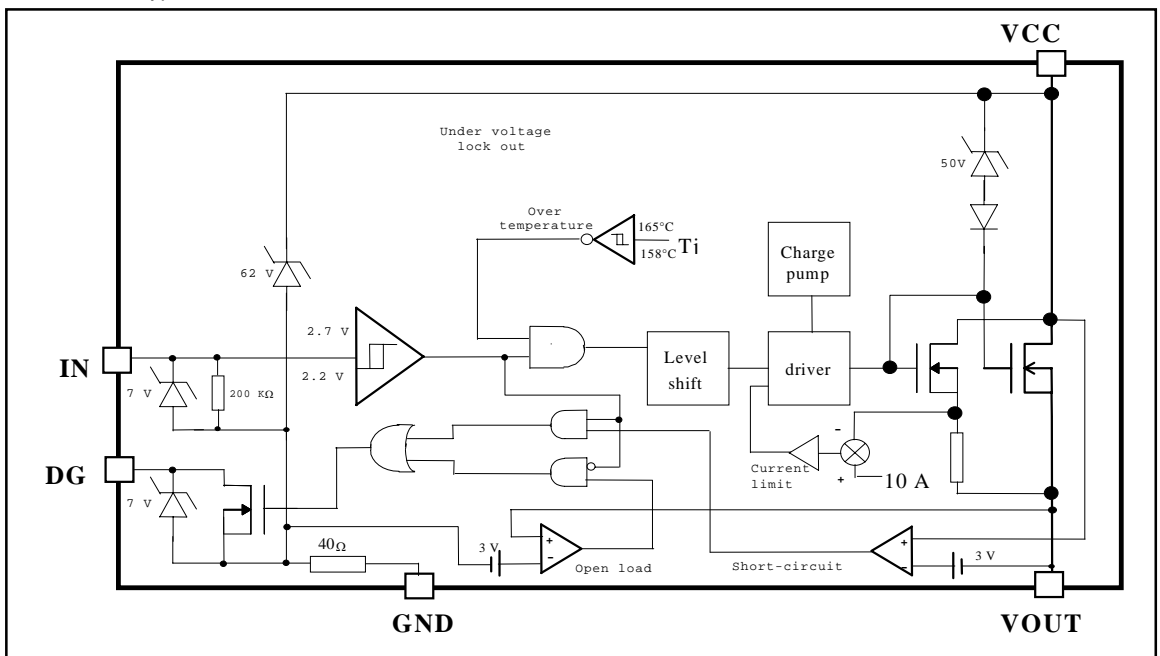
## Protection Characteristics

Symbol	Parameter	Min.	Typ.	Max.	Units	Test Conditions
$I_{lim}$	Internal current limit	—	10	—	A	$V_{out} = 0V$
$T_{sd+}$	Over-temp. positive going threshold	—	165	—	$^{\circ}C$	See fig. 2
$T_{sd-}$	Over-temp. negative going threshold	—	158	—	$^{\circ}C$	See fig. 2
$V_{sc}$	Short-circuit detection voltage (3)	—	3	—	V	See fig. 2
$V_{open\ load}$	Open load detection threshold	—	3	—	V	

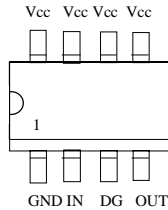
(3) Referenced to  $V_{CC}$

## Functional Block Diagram

All values are typical

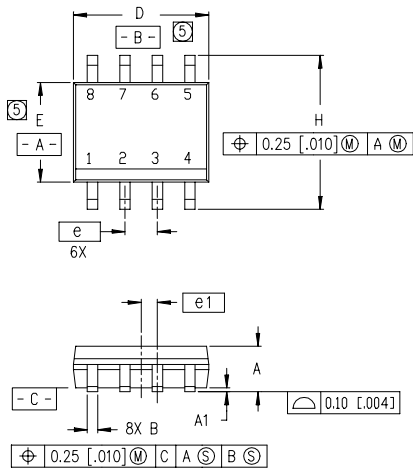


### Lead Assignments

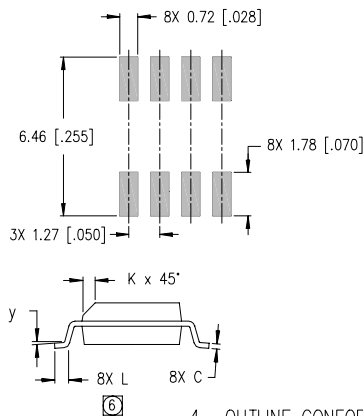


8 Lead SOIC

### Case Outline - 8 Lead SOIC



RECOMMENDED FOOTPRINT



DIM	INCHES		MILLIMETERS	
	MIN	MAX	MIN	MAX
A	.0532	.0688	1.35	1.75
A1	.0040	.0098	0.10	0.25
B	.014	.018	0.36	0.46
C	.0075	.0098	0.19	0.25
D	.189	.196	4.80	4.98
E	.150	.157	3.81	3.99
e	.050	BASIC	1.27	BASIC
e1	.025	BASIC	0.635	BASIC
H	.2284	.2440	5.80	6.20
K	.011	.019	0.28	0.48
L	.016	.050	0.41	1.27
y	0"	8"	0"	8"

NOTES:

1. DIMENSIONING & TOLERANCING PER ANSI Y14.5M-1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS ARE SHOWN IN MILLIMETERS [INCHES].

4. OUTLINE CONFORMS TO JEDEC OUTLINE MS-012AA.
5. DIMENSION DOES NOT INCLUDE MOLD PROTRUSIONS. MOLD PROTRUSIONS NOT TO EXCEED 0.25 [.006].
6. DIMENSION IS THE LENGTH OF LEAD FOR SOLDERING TO A SUBSTRATE.

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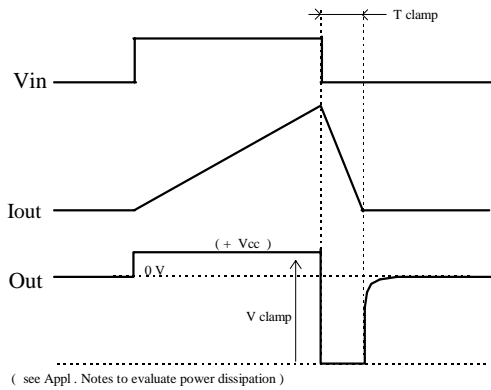


Figure 1 - Active clamp waveforms

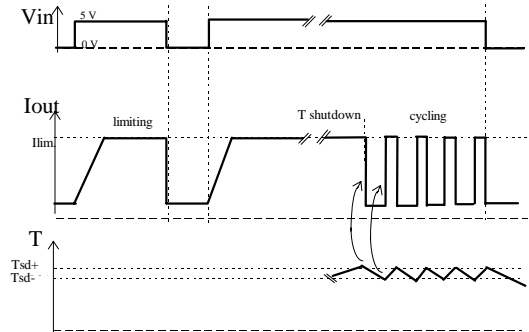


Figure 2 - Protection timing diagram

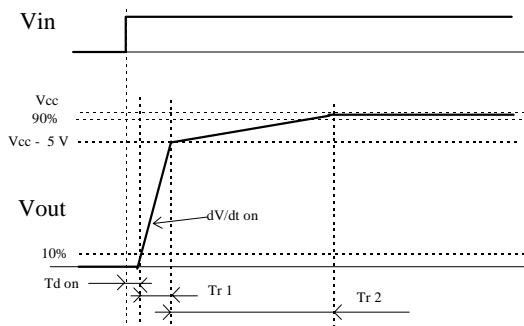


Figure 3 - Switching times definition (turn-on)

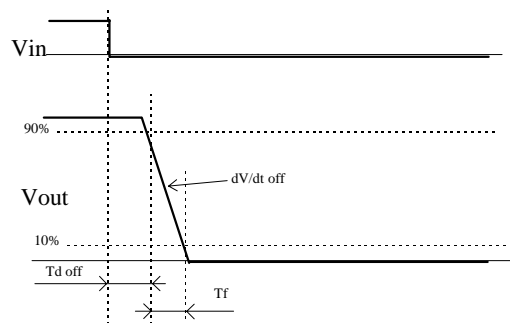


Figure 4 - Switching times definition (turn-off)

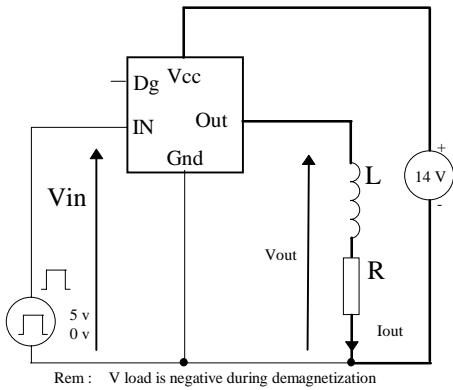


Figure 5 - Active clamp test circuit

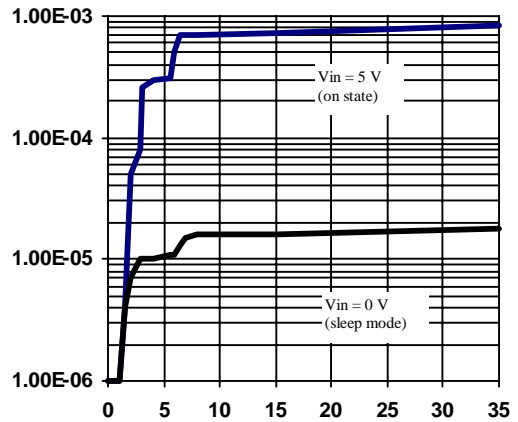


Figure 6 -  $I_{cc}$  (mA) Vs  $V_{cc}$  (V)

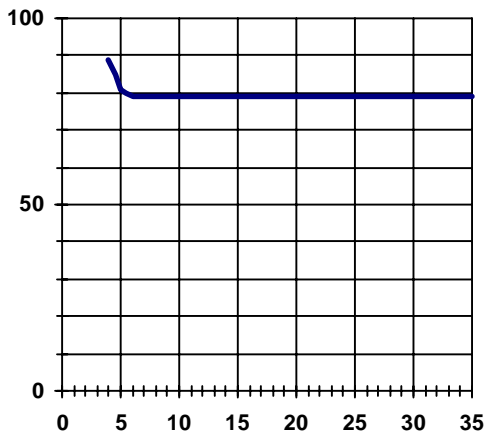


Figure 7 -  $R_{ds(on)}$  (mW) Vs  $V_{cc}$  (V)

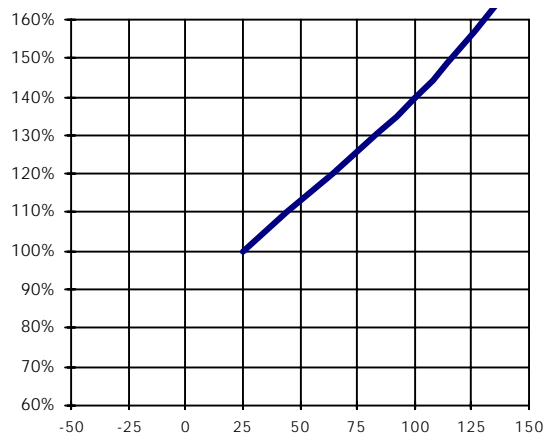


Figure 8 - Normalized  $R_{ds(on)}$  Vs  $T_j$  (°C)

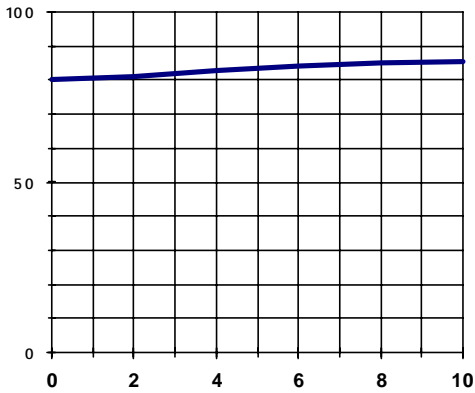


Figure 9 -  $R_{ds(on)}$  (mW) Vs  $I_{out}$  (A)

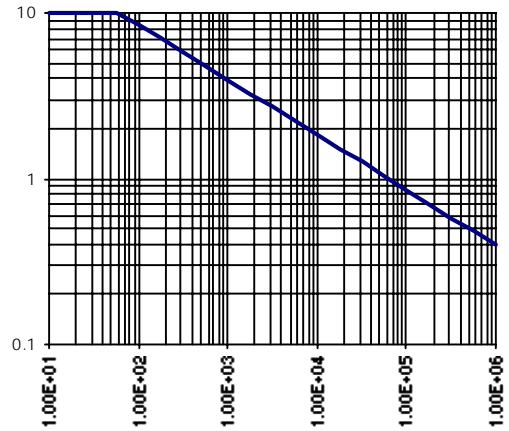


Figure 10 - Max.  $I_{out}$  (A) Vs Load Inductance ( $\mu H$ )

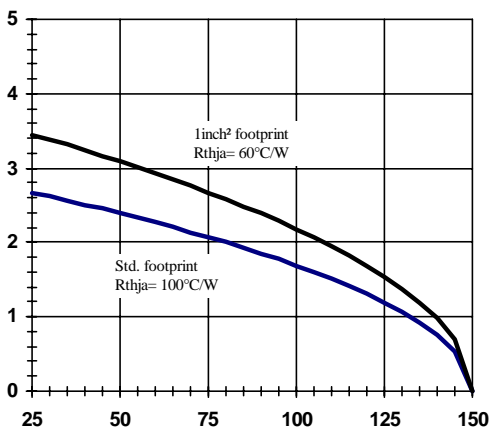


Figure 11 - Max load current (A) Vs  $T_{amb}$  ( $^{\circ}C$ )

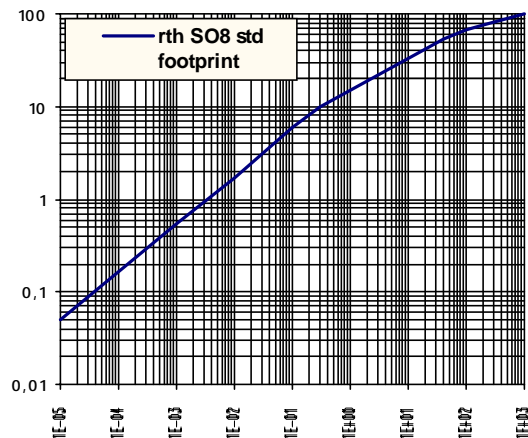


Figure 12 - Transient Thermal Impedance ( $^{\circ}C/W$ ) Vs Time (s)



International  
**IOR** Rectifier

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*Data and specifications subject to change without notice. 9/20/98*